Renesas Electronics America Inc - R5F51306ADFM#30 Datasheet

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	52
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 14x12b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51306adfm-30

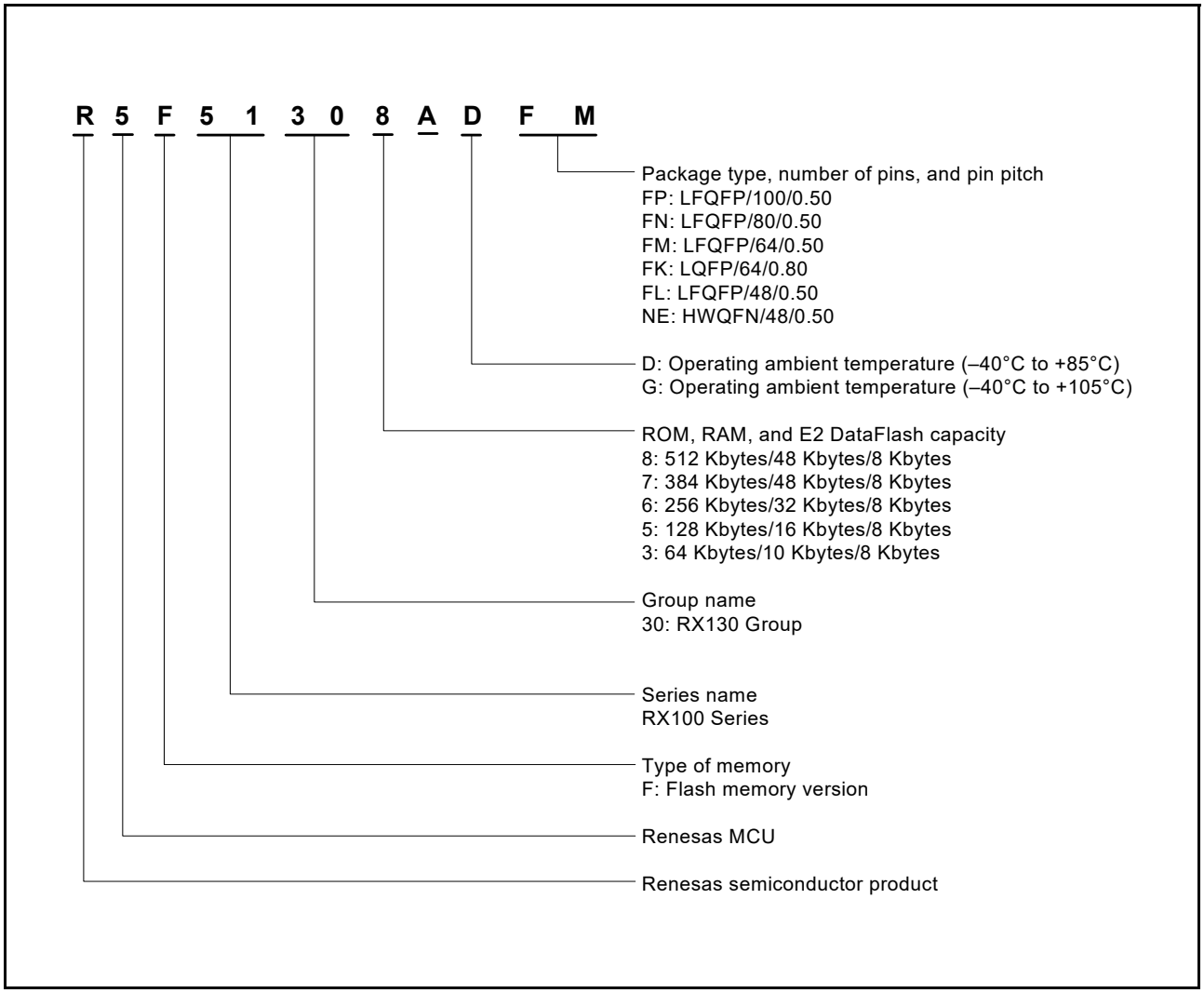


Figure 1.1 How to Read the Product Part Number

1.3 Block Diagram

Figure 1.2 shows a block diagram.

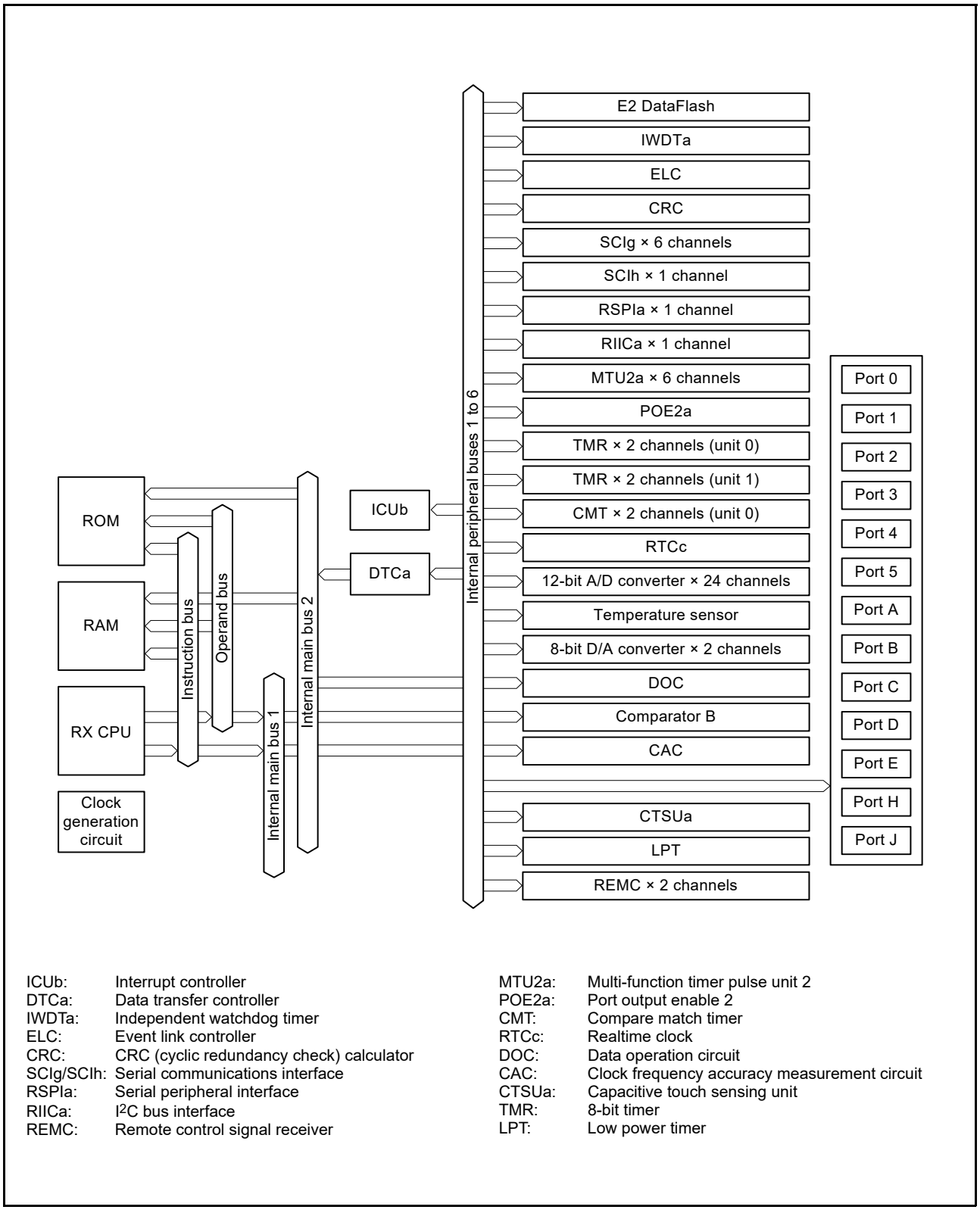


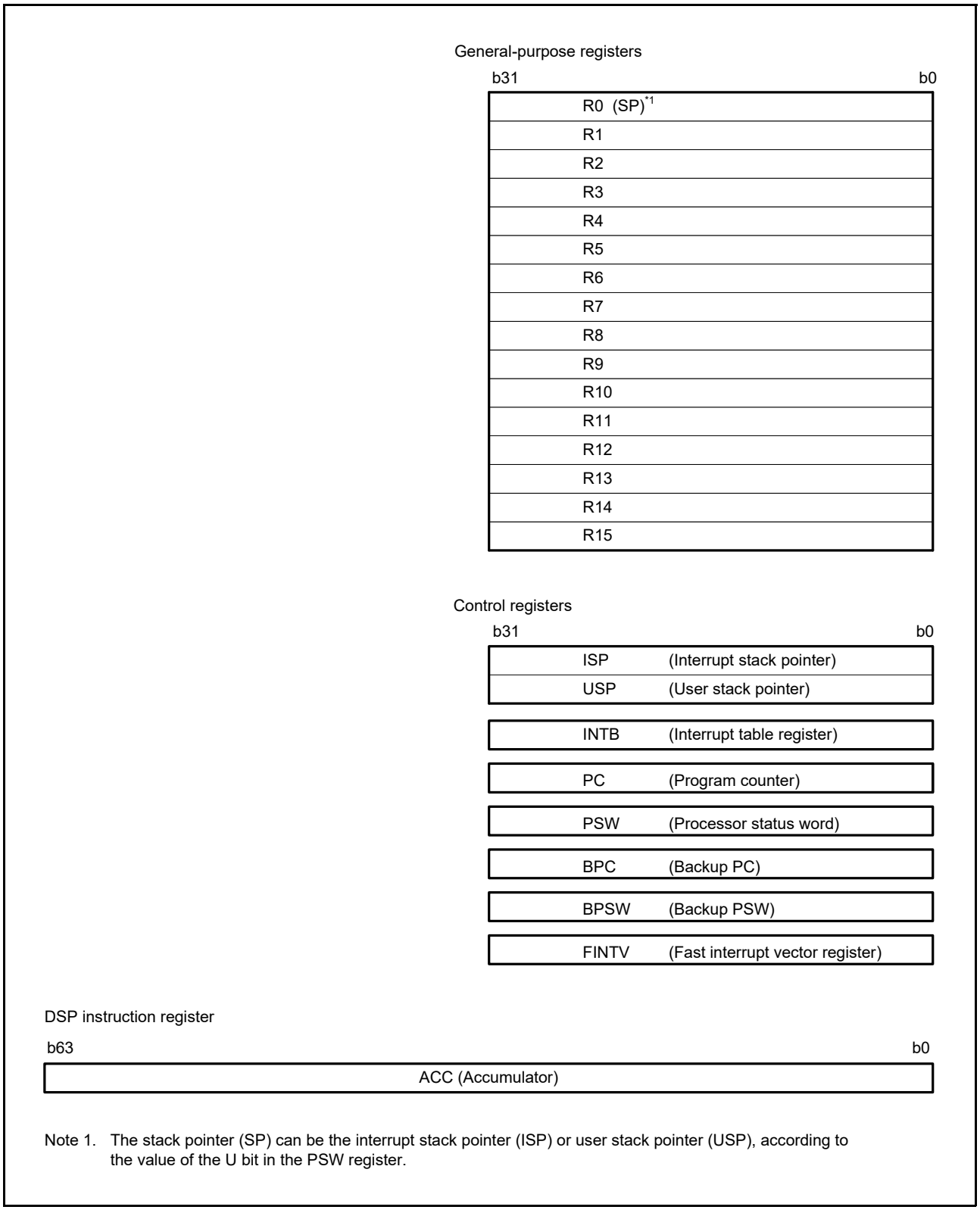
Figure 1.2 Block Diagram

Table 1.5 List of Pins and Pin Functions (100-Pin LFQFP) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TMR, POE)	Communications (SCIg, SCIh, RSPI, RIIC, REMC)	Touch sensing	Others
1		P06*1				
2		P03*1				DA0
3		P04*1				
4		PJ3	MTIOC3C	CTS6#/RTS6#/SS6#		
5	VCL					
6		PJ1	MTIOC3A			
7	MD					FINED
8	XCIN					
9	XCOUT					
10	RES#					
11	XTAL	P37				
12	VSS					
13	EXTAL	P36				
14	VCC					
15		P35				NMI
16		P34	MTIOC0A/TMCI3/POE2#	SCK6		IRQ4
17		P33	MTIOC0D/TMRI3/POE3#	RXD6/SMISO6/SSCL6		IRQ3
18		P32	MTIOC0C/TMO3	TXD6/SMOSI6/SSDA6	TS0	IRQ2/RTCOUT
19		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	TS1	IRQ1
20		P30	MTIOC4B/POE8#/TMRI3	RXD1/SMISO1/SSCL1	TS2	IRQ0
21		P27	MTIOC2B/TMCI3	SCK1	TS3	
22		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1	TS4	
23		P25	MTIOC4C/MTCLKB			ADTRG0#
24		P24	MTIOC4A/MTCLKA/TMRI1			
25		P23	MTIOC3D/MTCLKD	CTS0#/RTS0#/SS0#		
26		P22	MTIOC3B/MTCLKC/TMO0	SCK0		
27		P21	MTIOC1B/TMCI0	RXD0/SMISO0/SSCL0		
28		P20	MTIOC1A/TMRI0	TXD0/SMOSI0/SSDA0		
29	(5V tolerant)	P17	MTIOC3A/MTIOC3B/TMO1/ POE8#	SCK1/MISOA/SDA		IRQ7
30	(5V tolerant)	P16	MTIOC3C/MTIOC3D/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/SCL		IRQ6/RTCOUT/ ADTRG0#
31		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1	TS5	IRQ5
32		P14	MTIOC3A/MTCLKA/TMRI2	CTS1#/RTS1#/SS1#	TS6	IRQ4
33	(5V tolerant)	P13	MTIOC0B/TMO3	SDA		IRQ3
34	(5V tolerant)	P12	TMCI1	SCL		IRQ2
35		PH3	TMCI0		TS7	
36		PH2	TMRI0		TS8	IRQ1
37		PH1	TMO0		TS9	IRQ0
38		PH0			TS10	CACREF
39		P55	MTIOC4D/TMO3		TS11	
40		P54	MTIOC4B/TMCI1		TS12	
41		P53				
42		P52		PMC1		
43		P51		PMC0		
44		P50				
45		PC7	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/MISOA	TS13	CACREF
46		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA	TS14	
47		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA	TS15	
48		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/SSLA0	TSCAP	
49		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5	TS16	
50		PC2	MTIOC4B	RXD5/SMISO5/SSCL5/SSLA3	TS17	
51		PC1	MTIOC3A	SCK5/SSLA2		
52		PC0	MTIOC3C	CTS5#/RTS5#/SS5#/SSLA1		

2. CPU

Figure 2.1 shows the register set of the CPU.



Note 1. The stack pointer (SP) can be the interrupt stack pointer (ISP) or user stack pointer (USP), according to the value of the U bit in the PSW register.

Figure 2.1 Register Set of the CPU

3. Address Space

3.1 Address Space

This MCU has a 4-Gbyte address space, consisting of the range of addresses from 0000 0000h to FFFF FFFFh. That is, linear access to an address space of up to 4 Gbytes is possible, and this contains both program and data areas.
Figure 3.1 shows the memory maps.

Table 4.1 List of I/O Registers (Address Order) (14 / 18)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles
0008 C147h	MPC	P07 Pin Function Control Register	P07PFS	8	8	2 or 3 PCLKB
0008 C14Ah	MPC	P12 Pin Function Control Register	P12PFS	8	8	2 or 3 PCLKB
0008 C14Bh	MPC	P13 Pin Function Control Register	P13PFS	8	8	2 or 3 PCLKB
0008 C14Ch	MPC	P14 Pin Function Control Register	P14PFS	8	8	2 or 3 PCLKB
0008 C14Dh	MPC	P15 Pin Function Control Register	P15PFS	8	8	2 or 3 PCLKB
0008 C14Eh	MPC	P16 Pin Function Control Register	P16PFS	8	8	2 or 3 PCLKB
0008 C14Fh	MPC	P17 Pin Function Control Register	P17PFS	8	8	2 or 3 PCLKB
0008 C150h	MPC	P20 Pin Function Control Register	P20PFS	8	8	2 or 3 PCLKB
0008 C151h	MPC	P21 Pin Function Control Register	P21PFS	8	8	2 or 3 PCLKB
0008 C152h	MPC	P22 Pin Function Control Register	P22PFS	8	8	2 or 3 PCLKB
0008 C153h	MPC	P23 Pin Function Control Register	P23PFS	8	8	2 or 3 PCLKB
0008 C154h	MPC	P24 Pin Function Control Register	P24PFS	8	8	2 or 3 PCLKB
0008 C155h	MPC	P25 Pin Function Control Register	P25PFS	8	8	2 or 3 PCLKB
0008 C156h	MPC	P26 Pin Function Control Register	P26PFS	8	8	2 or 3 PCLKB
0008 C157h	MPC	P27 Pin Function Control Register	P27PFS	8	8	2 or 3 PCLKB
0008 C158h	MPC	P30 Pin Function Control Register	P30PFS	8	8	2 or 3 PCLKB
0008 C159h	MPC	P31 Pin Function Control Register	P31PFS	8	8	2 or 3 PCLKB
0008 C15Ah	MPC	P32 Pin Function Control Register	P32PFS	8	8	2 or 3 PCLKB
0008 C15Bh	MPC	P33 Pin Function Control Register	P33PFS	8	8	2 or 3 PCLKB
0008 C15Ch	MPC	P34 Pin Function Control Register	P34PFS	8	8	2 or 3 PCLKB
0008 C160h	MPC	P40 Pin Function Control Register	P40PFS	8	8	2 or 3 PCLKB
0008 C161h	MPC	P41 Pin Function Control Register	P41PFS	8	8	2 or 3 PCLKB
0008 C162h	MPC	P42 Pin Function Control Register	P42PFS	8	8	2 or 3 PCLKB
0008 C163h	MPC	P43 Pin Function Control Register	P43PFS	8	8	2 or 3 PCLKB
0008 C164h	MPC	P44 Pin Function Control Register	P44PFS	8	8	2 or 3 PCLKB
0008 C165h	MPC	P45 Pin Function Control Register	P45PFS	8	8	2 or 3 PCLKB
0008 C166h	MPC	P46 Pin Function Control Register	P46PFS	8	8	2 or 3 PCLKB
0008 C167h	MPC	P47 Pin Function Control Register	P47PFS	8	8	2 or 3 PCLKB
0008 C169h	MPC	P51 Pin Function Control Register	P51PFS	8	8	2 or 3 PCLKB
0008 C16Ah	MPC	P52 Pin Function Control Register	P52PFS	8	8	2 or 3 PCLKB
0008 C16Ch	MPC	P54 Pin Function Control Register	P54PFS	8	8	2 or 3 PCLKB
0008 C16Dh	MPC	P55 Pin Function Control Register	P55PFS	8	8	2 or 3 PCLKB
0008 C190h	MPC	PA0 Pin Function Control Register	PA0PFS	8	8	2 or 3 PCLKB
0008 C191h	MPC	PA1 Pin Function Control Register	PA1PFS	8	8	2 or 3 PCLKB
0008 C192h	MPC	PA2 Pin Function Control Register	PA2PFS	8	8	2 or 3 PCLKB
0008 C193h	MPC	PA3 Pin Function Control Register	PA3PFS	8	8	2 or 3 PCLKB
0008 C194h	MPC	PA4 Pin Function Control Register	PA4PFS	8	8	2 or 3 PCLKB
0008 C195h	MPC	PA5 Pin Function Control Register	PA5PFS	8	8	2 or 3 PCLKB
0008 C196h	MPC	PA6 Pin Function Control Register	PA6PFS	8	8	2 or 3 PCLKB
0008 C197h	MPC	PA7 Pin Function Control Register	PA7PFS	8	8	2 or 3 PCLKB
0008 C198h	MPC	PB0 Pin Function Control Register	PB0PFS	8	8	2 or 3 PCLKB
0008 C199h	MPC	PB1 Pin Function Control Register	PB1PFS	8	8	2 or 3 PCLKB
0008 C19Ah	MPC	PB2 Pin Function Control Register	PB2PFS	8	8	2 or 3 PCLKB
0008 C19Bh	MPC	PB3 Pin Function Control Register	PB3PFS	8	8	2 or 3 PCLKB
0008 C19Ch	MPC	PB4 Pin Function Control Register	PB4PFS	8	8	2 or 3 PCLKB
0008 C19Dh	MPC	PB5 Pin Function Control Register	PB5PFS	8	8	2 or 3 PCLKB
0008 C19Eh	MPC	PB6 Pin Function Control Register	PB6PFS	8	8	2 or 3 PCLKB
0008 C19Fh	MPC	PB7 Pin Function Control Register	PB7PFS	8	8	2 or 3 PCLKB
0008 C1A0h	MPC	PC0 Pin Function Control Register	PC0PFS	8	8	2 or 3 PCLKB
0008 C1A1h	MPC	PC1 Pin Function Control Register	PC1PFS	8	8	2 or 3 PCLKB
0008 C1A2h	MPC	PC2 Pin Function Control Register	PC2PFS	8	8	2 or 3 PCLKB
0008 C1A3h	MPC	PC3 Pin Function Control Register	PC3PFS	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (18 / 18)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles
007F C0B2h	FLASH	Flash Access Window Start Address Monitor Register	FAWSMR	16	16	2 or 3 FCLK
007F C0B4h	FLASH	Flash Access Window End Address Monitor Register	FAWEMR	16	16	2 or 3 FCLK
007F C0B6h	FLASH	Flash Initial Setting Register	FISR	8	8	2 or 3 FCLK
007F C0B7h	FLASH	Flash Extra Area Control Register	FEXCR	8	8	2 or 3 FCLK
007F C0B8h	FLASH	Flash Error Address Monitor Register L	FEAML	16	16	2 or 3 FCLK
007F C0BAh	FLASH	Flash Error Address Monitor Register H	FEAMH	8	8	2 or 3 FCLK
007F C0C0h	FLASH	Protection Unlock Register	FPR	8	8	2 or 3 FCLK
007F C0C1h	FLASH	Protection Unlock Status Register	FPSR	8	8	2 or 3 FCLK
007F C0C2h	FLASH	Flash Read Buffer Register L	FRBL	16	16	2 or 3 FCLK
007F C0C4h	FLASH	Flash Read Buffer Register H	FRBH	16	16	2 or 3 FCLK
007F FF80h	FLASH	Flash P/E Mode Control Register	FPMCR	8	8	2 or 3 FCLK
007F FF81h	FLASH	Flash Area Select Register	FASR	8	8	2 or 3 FCLK
007F FF82h	FLASH	Flash Processing Start Address Register L	FSARL	16	16	2 or 3 FCLK
007F FF84h	FLASH	Flash Processing Start Address Register H	FSARH	8	8	2 or 3 FCLK
007F FF85h	FLASH	Flash Control Register	FCR	8	8	2 or 3 FCLK
007F FF86h	FLASH	Flash Processing End Address Register L	FEARL	16	16	2 or 3 FCLK
007F FF88h	FLASH	Flash Processing End Address Register H	FEARH	8	8	2 or 3 FCLK
007F FF89h	FLASH	Flash Reset Register	FRESETR	8	8	2 or 3 FCLK
007F FF8Ah	FLASH	Flash Status Register 0	FSTATR0	8	8	2 or 3 FCLK
007F FF8Bh	FLASH	Flash Status Register 1	FSTATR1	8	8	2 or 3 FCLK
007F FF8Ch	FLASH	Flash Write Buffer Register L	FWBL	16	16	2 or 3 FCLK
007F FF8Eh	FLASH	Flash Write Buffer Register H	FWBH	16	16	2 or 3 FCLK
007F FFB2h	FLASH	Flash P/E Mode Entry Register	FENTRYR	16	16	2 or 3 FCLK
007F FFBEh	CTSU	CTSU Reference Current Calibration Register	CTSUTRMR	8	8	2 or 3 FCLK

5.2 DC Characteristics

Table 5.3 DC Characteristics (1)

Conditions: 2.7 V ≤ VCC ≤ 5.5 V, 2.7 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	RIIC input pin (except for SMBus)	V_{IH}	VCC × 0.7	—	5.8	V	
	Ports P12, P13, P16, P17 (5 V tolerant)		VCC × 0.8	—	5.8		
	Ports P14, P15, Ports P20 to P27, Ports P30 to P37, Ports P50 to P55, Ports PA0 to PA7, Ports PB0 to PB7, Ports PC0 to PC7, Ports PD0 to PD7, Ports PE0 to PE7, Ports PH0 to PH3, Ports PJ1, PJ3, RES#		VCC × 0.8	—	VCC + 0.3		
	Ports P03 to P07, Ports P40 to P47, Ports PJ6, PJ7		AVCC0 × 0.8	—	AVCC0 + 0.3		
	RIIC input pin (except for SMBus)	V_{IL}	–0.3	—	VCC × 0.3		
	Ports P03 to P07, Ports P40 to P47, Ports PJ6, PJ7		–0.3	—	AVCC0 × 0.2		
	Ports other than above		–0.3	—	VCC × 0.2		
	RIIC input pin (except for SMBus)	ΔV_T	VCC × 0.05	—	—		
	Ports P12, P13, P16, P17 (5 V tolerant)		VCC × 0.05	—	—		
	Ports P03 to P07, Ports P40 to P47, Ports PJ6, PJ7		AVCC0 × 0.1	—	—		
	Ports other than above		VCC × 0.1	—	—		
Input level voltage (except for Schmitt trigger input pins)	MD	V_{IH}	VCC × 0.9	—	VCC + 0.3	V	
	EXTAL (external clock input)		VCC × 0.8	—	VCC + 0.3		
	RIIC input pin (SMBus)		2.1	—	VCC + 0.3		
	MD	V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL (external clock input)		–0.3	—	VCC × 0.2		
	RIIC input pin (SMBus)		–0.3	—	0.8		

Table 5.4 DC Characteristics (2)

Conditions: 1.8 V ≤ VCC = AVCC0 < 2.0 V, 2.0 V ≤ VCC < 2.7 V, 2.0 V ≤ AVCC0 < 2.7 V, VSS = AVSS0 = 0 V, Ta = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	Ports P12, P13, P16, P17 (5 V tolerant)	V_{IH}	VCC × 0.8	—	5.8	V	
	Ports P14, P15, Ports P20 to P27, Ports P30 to P37, Ports P50 to P55, Ports PA0 to PA7, Ports PB0 to PB7, Ports PC0 to PC7, Ports PD0 to PD7, Ports PE0 to PE7, Ports PH0 to PH3, Ports PJ1, PJ3, RES#		VCC × 0.8	—	VCC + 0.3		
	Ports P03 to P07, Ports P40 to P47, Ports PJ6, PJ7		AVCC0 × 0.8	—	AVCC0 + 0.3		
	Ports P03 to P07, Ports P40 to P47, Ports PJ6, PJ7	V_{IL}	–0.3	—	AVCC0 × 0.2		
	Ports other than above		–0.3	—	VCC × 0.2		
	Ports P03 to P07, Ports P40 to P47, Ports PJ6, PJ7	ΔV_T	AVCC0 × 0.01	—	—		
	Ports other than above		VCC × 0.01	—	—		
Input level voltage (except for Schmitt trigger input pins)	MD	V_{IH}	VCC × 0.9	—	VCC + 0.3	V	
	EXTAL (external clock input)		VCC × 0.8	—	VCC + 0.3		
	MD	V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL (external clock input)		–0.3	—	VCC × 0.2		

Table 5.5 DC Characteristics (3)

Conditions: 1.8 V ≤ VCC = AVCC0 < 2.0 V, 2.0 V ≤ VCC ≤ 5.5 V, 2.0 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, Ta = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input leakage current	RES#, MD, port P35	$\lvert I_{in} \rvert$	—	—	1.0	μA	V_{in} = 0V, VCC
Three-state leakage current (off-state)	Ports for 5-V tolerant	$\lvert I_{TSI} \rvert$	—	—	1.0	μA	V_{in} = 0V, 5.8V
	Ports except for 5 V tolerant		—	—	0.2		V_{in} = 0V, VCC
Input capacitance	All input pins (except for port P35)	C_{in}	—	—	15	pF	V_{in} = 0mV, f = 1MHz, T_a = 25°C
	port P35		—	—	30		

Table 5.6 DC Characteristics (4)

Conditions: 1.8 V ≤ VCC = AVCC0 < 2.0 V, 2.0 V ≤ VCC < 5.5 V, 2.0 V ≤ AVCC0 < 5.5 V, VSS = AVSS0 = 0 V, Ta = –40 to +105°C

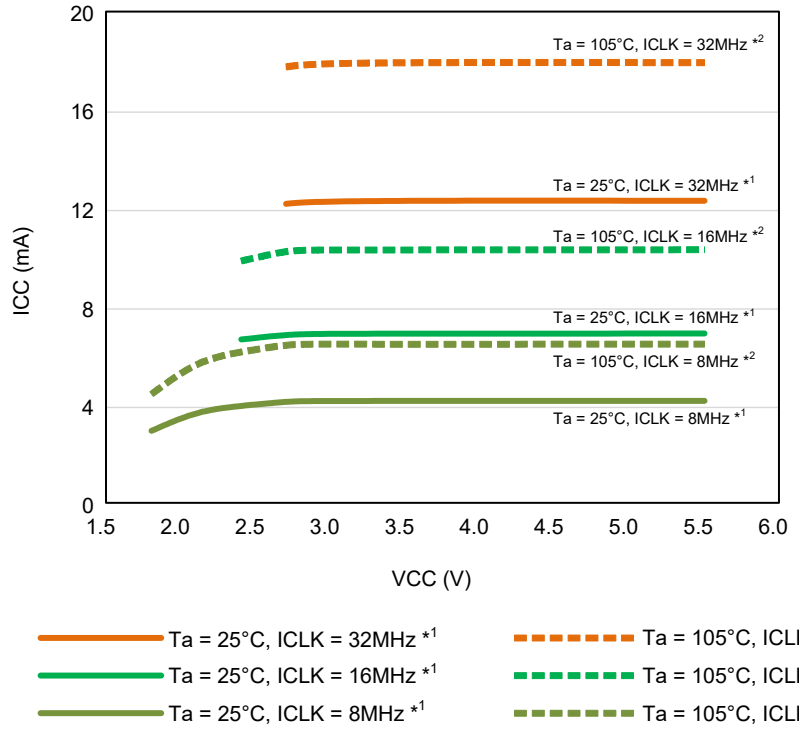
Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input pull-up resistor	All ports (except for port P35)	R_U	10	20	50	kΩ	V_{in} = 0 V

[Products with 128 Kbytes of flash memory or less (except for 100-pin packages)]

Table 5.7 DC Characteristics (5)

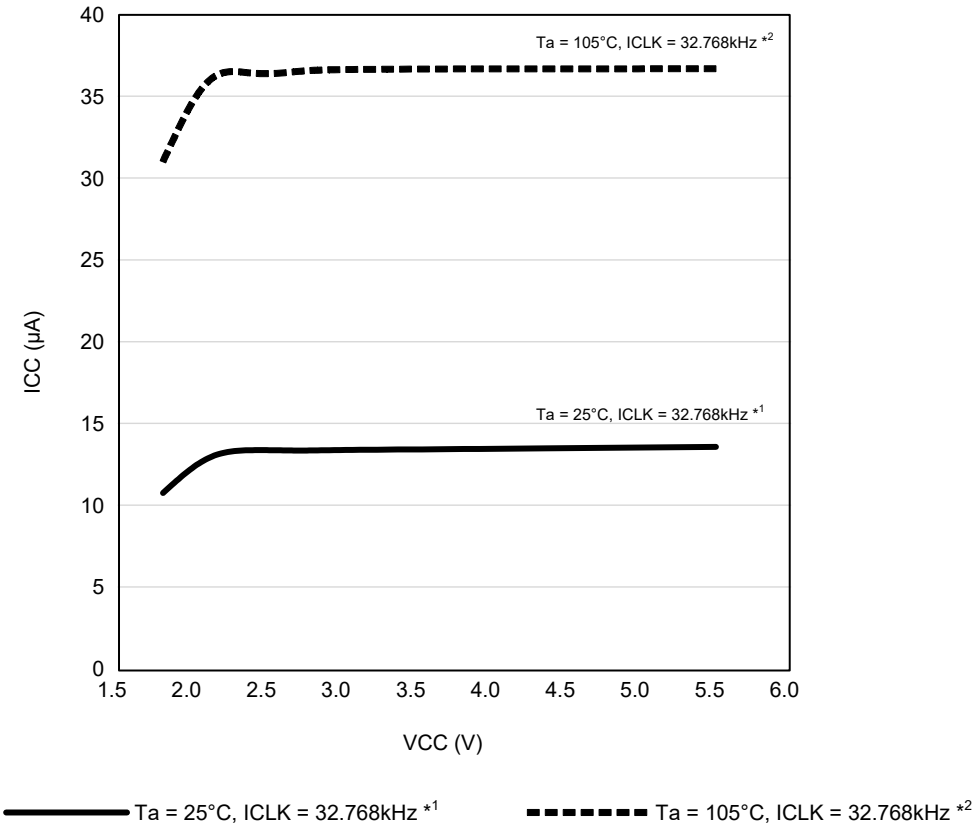
Conditions: 1.8 V ≤ VCC = AVCC0 < 2.0 V, 2.0 V ≤ VCC ≤ 5.5 V, 2.0 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, Ta = –40 to +105°C

Item					Symbol	Typ.	Max.	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 32MHz	I_{CC}	3.1	—	mA	
				ICLK = 16MHz		2.1	—		
				ICLK = 8MHz		1.6	—		
			All peripheral operation: Normal*3	ICLK = 32MHz		10.0	—		
				ICLK = 16MHz		5.7	—		
				ICLK = 8MHz		3.5	—		
			All peripheral operation: Max.*3	ICLK = 32MHz		—	17.5		
		Sleep mode	No peripheral operation*2	ICLK = 32MHz		1.6	—		
				ICLK = 16MHz		1.2	—		
				ICLK = 8MHz		1.1	—		
			All peripheral operation: Normal*3	ICLK = 32MHz		5.3	—		
				ICLK = 16MHz		3.2	—		
				ICLK = 8MHz		2.0	—		
		Deep sleep mode	No peripheral operation*2	ICLK = 32MHz		1.0	—		
				ICLK = 16MHz		0.9	—		
				ICLK = 8MHz		0.8	—		
			All peripheral operation: Normal*3	ICLK = 32MHz		4.2	—		
				ICLK = 16MHz		2.5	—		
				ICLK = 8MHz		1.7	—		
		Increase during flash rewrite*5				2.5	—		
	Middle-speed operating modes	Normal operating mode	No peripheral operation*6	ICLK = 12MHz	I_{CC}	1.9	—	mA	
				ICLK = 8MHz		1.2	—		
				ICLK = 4MHz		0.6	—		
				ICLK = 1MHz		0.3	—		
			All peripheral operation: Normal*7	ICLK = 12MHz		4.6	—		
				ICLK = 8MHz		3.2	—		
				ICLK = 4MHz		2.0	—		
				ICLK = 1MHz		0.9	—		
			All peripheral operation: Max.*7	ICLK = 12MHz		—	8.2		
		Sleep mode	No peripheral operation*6	ICLK = 12MHz	I_{CC}	1.2	—	mA	
				ICLK = 8MHz		0.8	—		
				ICLK = 4MHz		0.3	—		
				ICLK = 1MHz		0.2	—		
			All peripheral operation: Normal*7	ICLK = 12MHz		2.7	—		
				ICLK = 8MHz		1.9	—		
				ICLK = 4MHz		1.2	—		
				ICLK = 1MHz		0.7	—		



Note 1. All peripheral operation is normal. This does not include BGO operation. Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum. This does not include BGO operation. Average value of the tested upper-limit samples during product evaluation.

Figure 5.4 Voltage Dependency in High-Speed Operating Mode (Reference Data)



Note 1. All peripheral operation is normal. This does not include BGO operation. Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum. This does not include BGO operation. Average value of the tested upper-limit samples during product evaluation.

Figure 5.6 Voltage Dependency in Low-Speed Operating Mode (Reference Data)

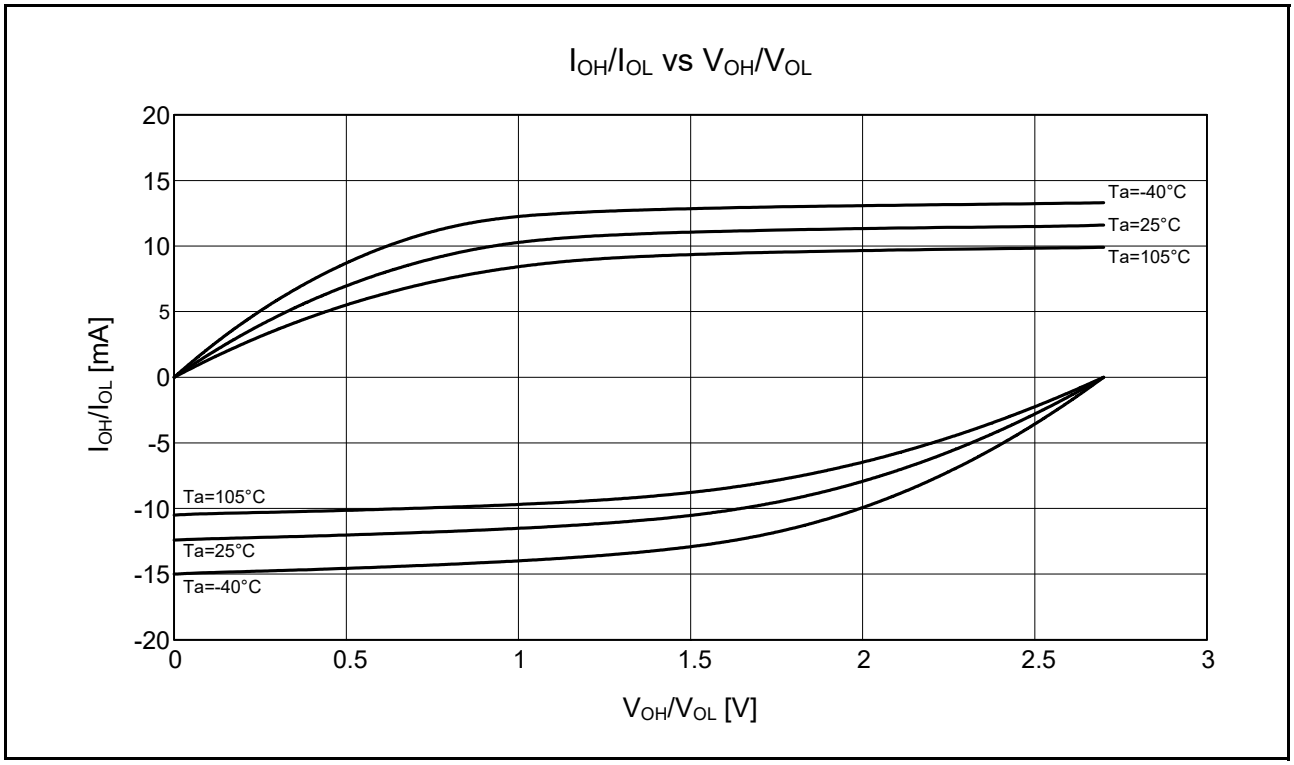


Figure 5.14 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 2.7 V When Normal Output is Selected (Reference Data)

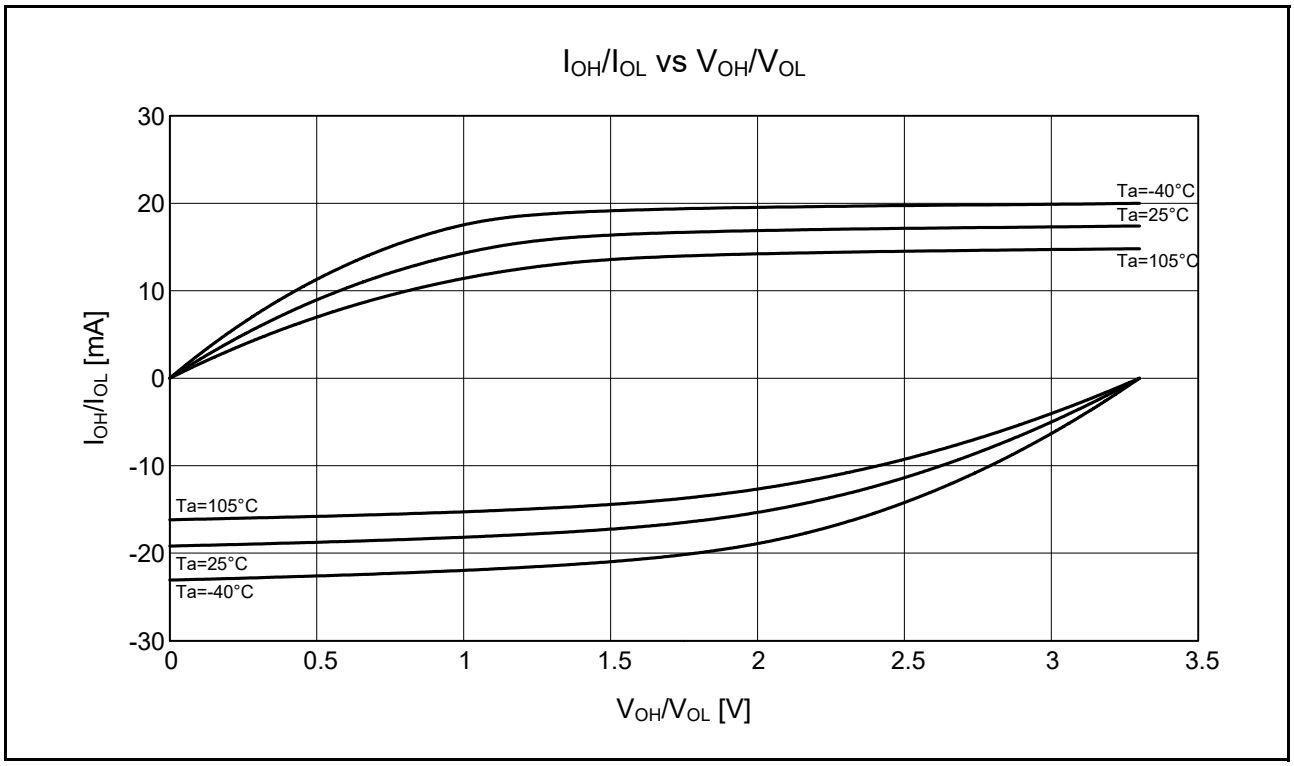


Figure 5.15 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 3.3 V When Normal Output is Selected (Reference Data)

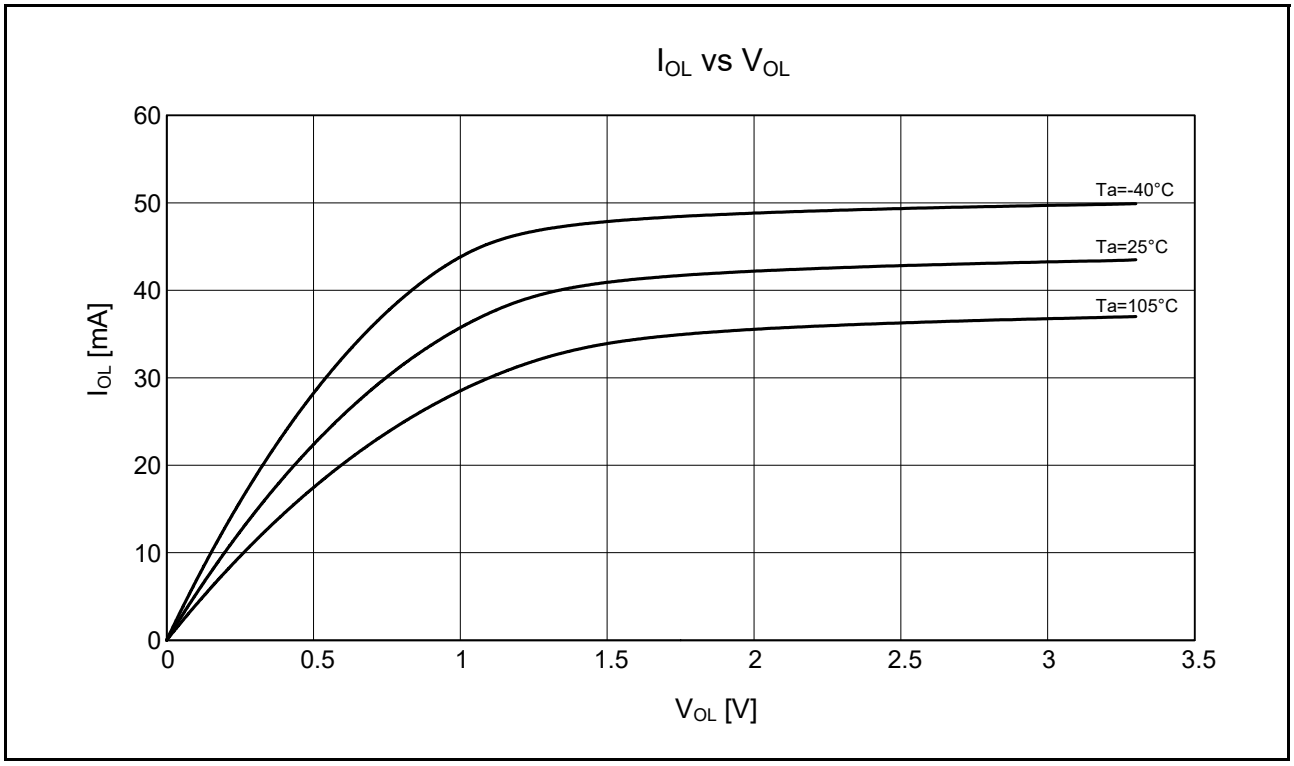


Figure 5.24 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 3.3 V (Reference Data)

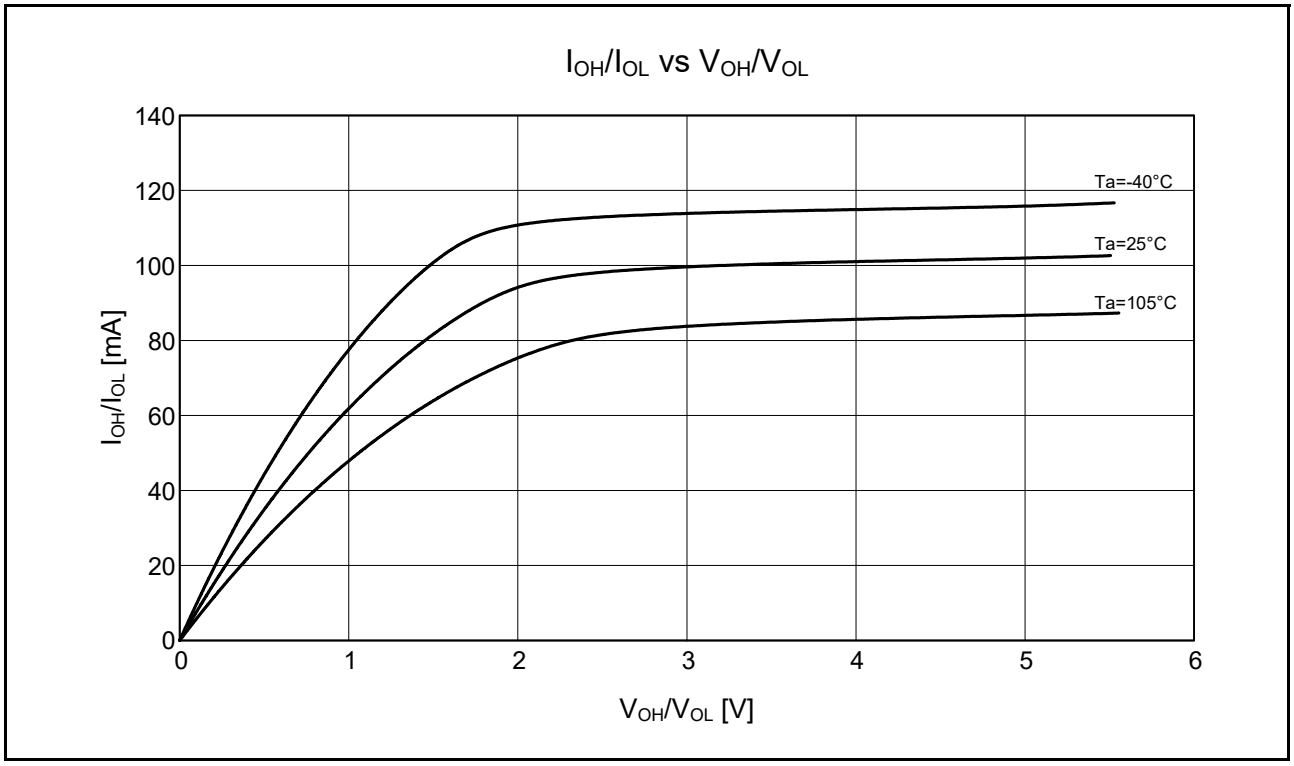


Figure 5.25 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 5.5 V (Reference Data)

5.4 A/D Conversion Characteristics

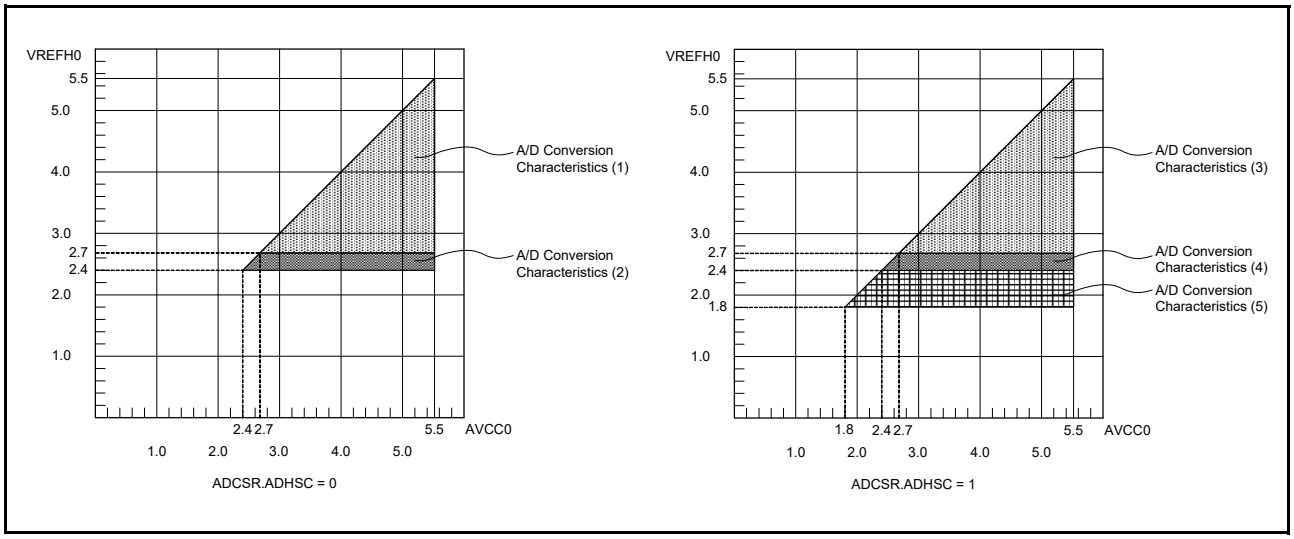
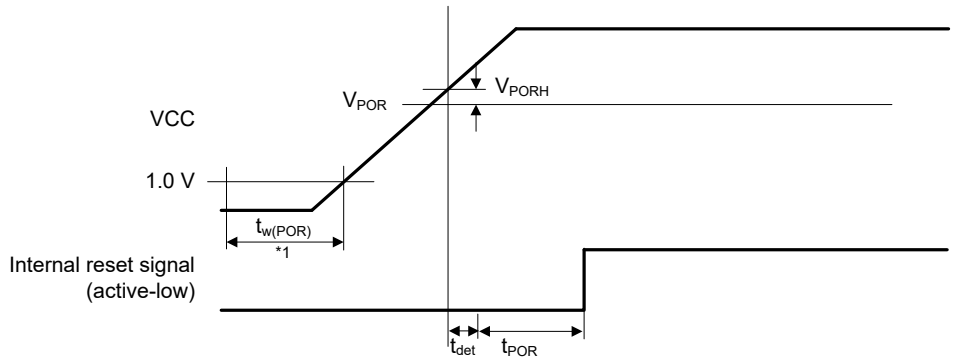


Figure 5.56 AVCC0 to VREFH0 Voltage Range



Note 1. $t_{w(POR)}$ is the time required for a power-on reset to be enabled while the external power VCC is being held below the valid voltage (1.0 V).
When VCC turns on, maintain $t_{w(POR)}$ for 1.0 ms or more.

Figure 5.62 Power-On Reset Timing

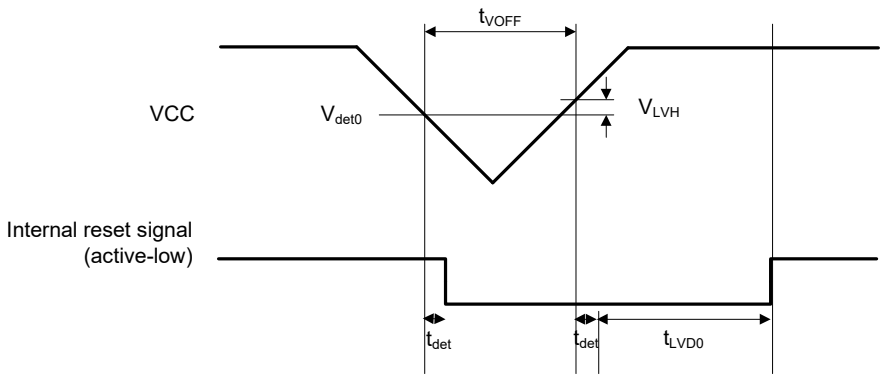


Figure 5.63 Voltage Detection Circuit Timing (V_{det0})

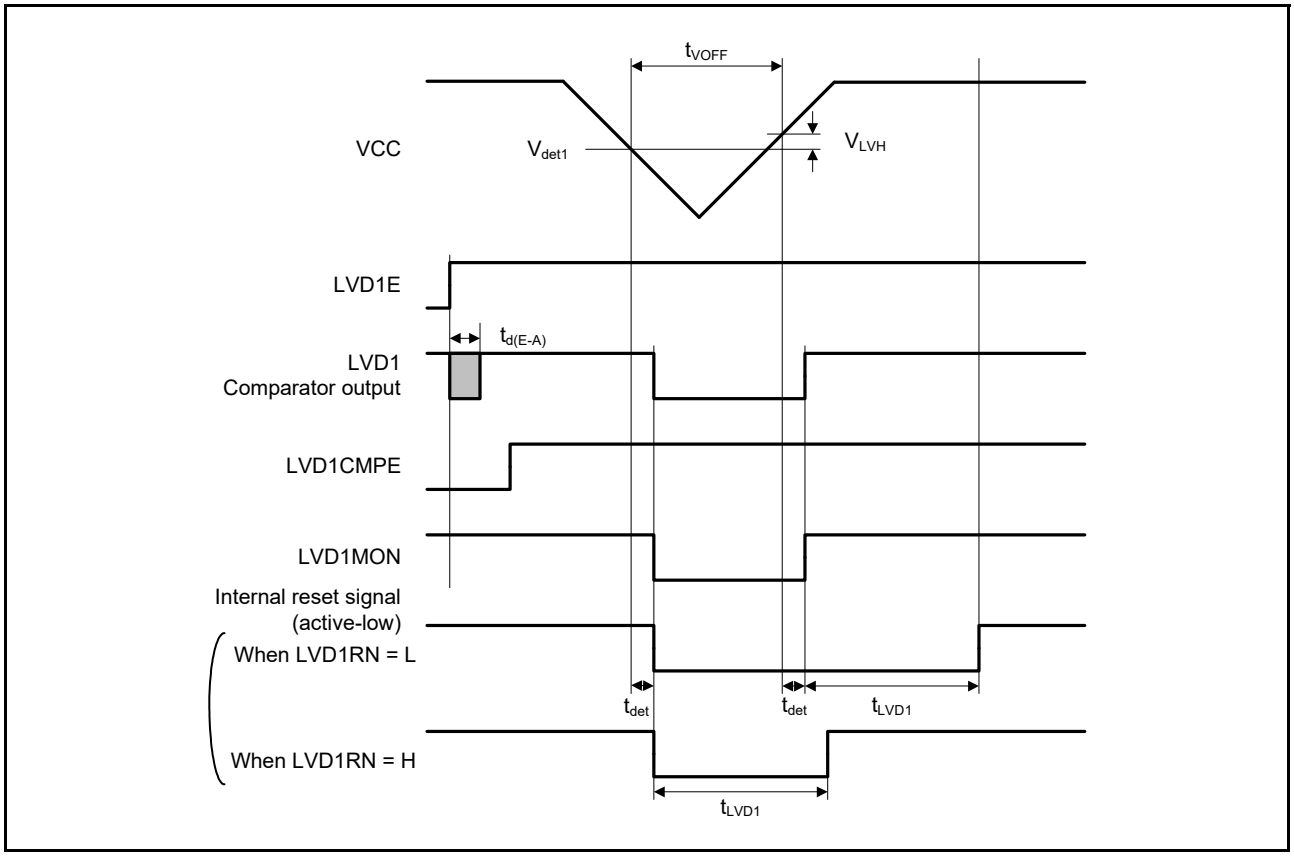


Figure 5.64 Voltage Detection Circuit Timing (V_{det1})

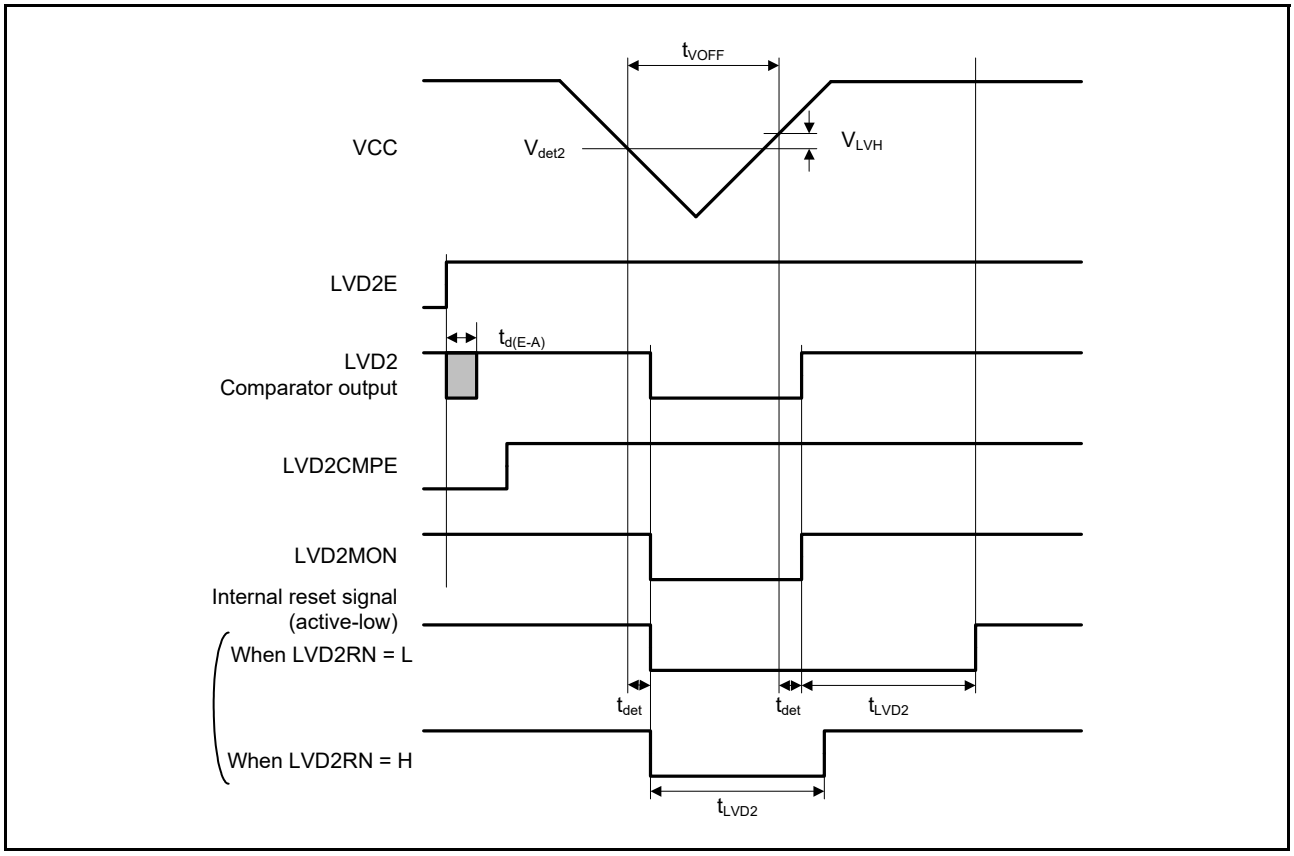


Figure 5.65 Voltage Detection Circuit Timing (V_{det2})

5.12 E2 DataFlash Characteristics (Flash Memory for Data Storage)

Table 5.55 E2 DataFlash Characteristics (1)

Item		Symbol	Min.	Typ.	Max.	Unit	Conditions
Reprogramming/erasure cycle*1		N_{DPEC}	100000	1000000	—	Times	
Data retention	After 10000 times of N_{DPEC}	t_{DDRP}	20*2, *3	—	—	Year	T_a = +85°C
	After 100000 times of N_{DPEC}		5*2, *3	—	—	Year	
	After 1000000 times of N_{DPEC}		—	1*2, *3	—	Year	T_a = +25°C

Note 1. The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100000), erasing can be performed n times for each block. For instance, when 1-byte programming is performed 1000 times for different addresses in 1-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. Characteristic when using the flash memory programmer and the self-programming library provided from Renesas Electronics.
Note 3. These results are obtained from reliability testing.

Table 5.56 E2 DataFlash Characteristics (2): high-speed operating mode

Conditions: 2.7 V ≤ VCC ≤ 5.5 V, 2.7 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +105°C

Item		Symbol	FCLK = 1 MHz			FCLK = 32 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1-byte	t_{DP1}	—	86	761	—	40.5	374	µs
Erasure time	1-Kbyte	t_{DE1K}	—	17.4	456	—	6.15	228	ms
	8-Kbyte	t_{DE8K}	—	60.4	499	—	9.3	231	ms
Blank check time	1-byte	t_{DBC1}	—	—	48	—	—	15.9	µs
	1-Kbyte	t_{DBC1K}	—	—	1.58	—	—	0.127	µs
Erase operation forcible stop time		t_{DSED}	—	—	21.5	—	—	12.8	µs
DataFlash STOP recovery time		t_{DSTOP}	5.0	—	—	5	—	—	µs

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK should be ±3.5%.

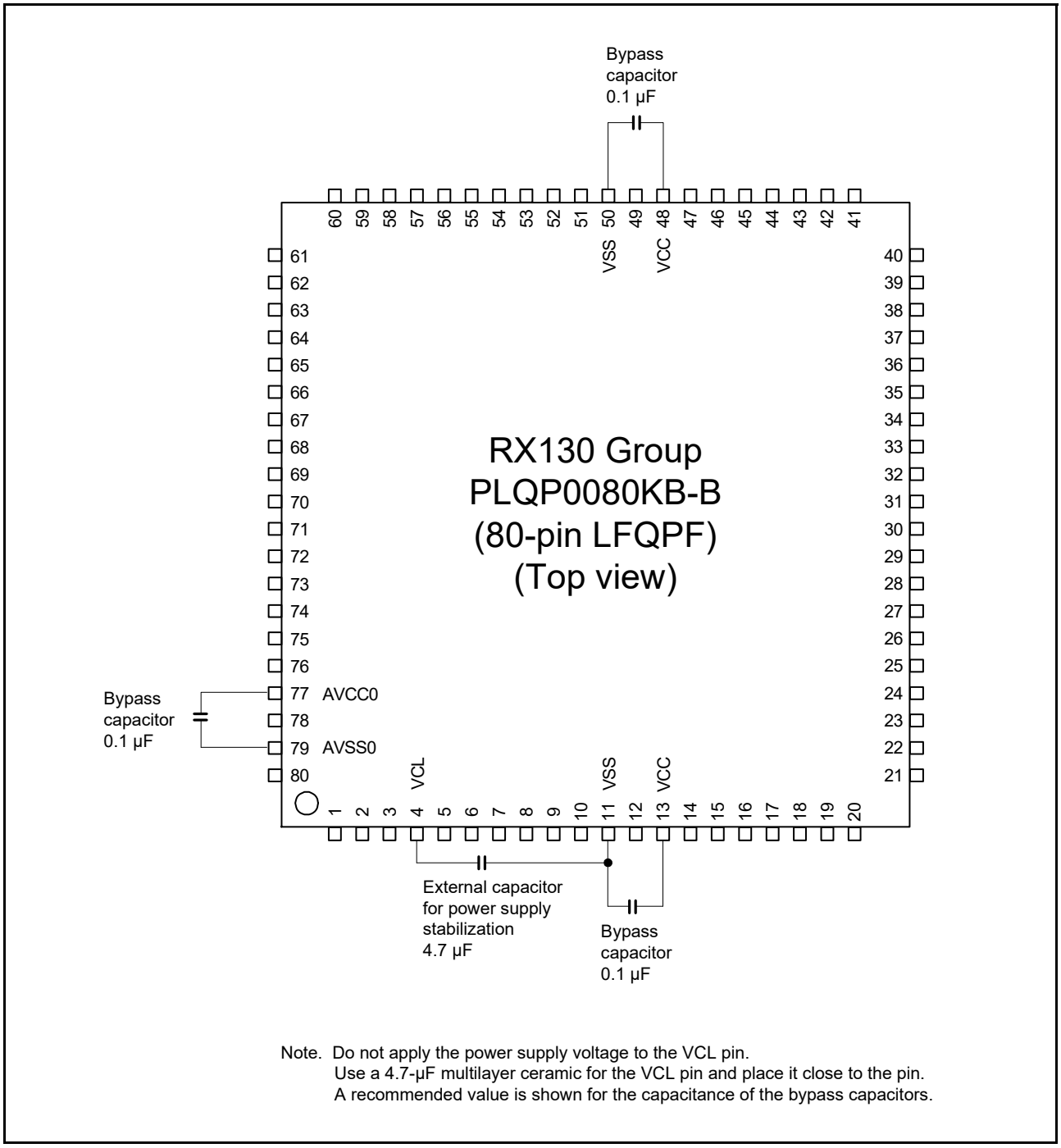
Table 5.57 E2 DataFlash Characteristics (3): middle-speed operating mode

Conditions: 1.8 V ≤ VCC = AVCC0 < 2.0 V, 2.0 V ≤ VCC ≤ 5.5 V, 2.0 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +85°C

Item		Symbol	FCLK = 1 MHz			FCLK = 8 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1-byte	t_{DP1}	—	126	1160	—	85.4	818	µs
Erasure time	1-Kbyte	t_{DE1K}	—	17.5	457	—	7.76	259	ms
	8-Kbyte	t_{DE8K}	—	60.5	500	—	4.2	66.9	ms
Blank check time	1-byte	t_{DBC1}	—	—	78	—	—	50	µs
	1-Kbyte	t_{DBC1K}	—	—	1.61	—	—	0.369	ms
Erase operation forcible stop time		t_{DSED}	—	—	33.5	—	—	25.5	µs
DataFlash STOP recovery time		t_{DSTOP}	720	—	—	720	—	—	ns

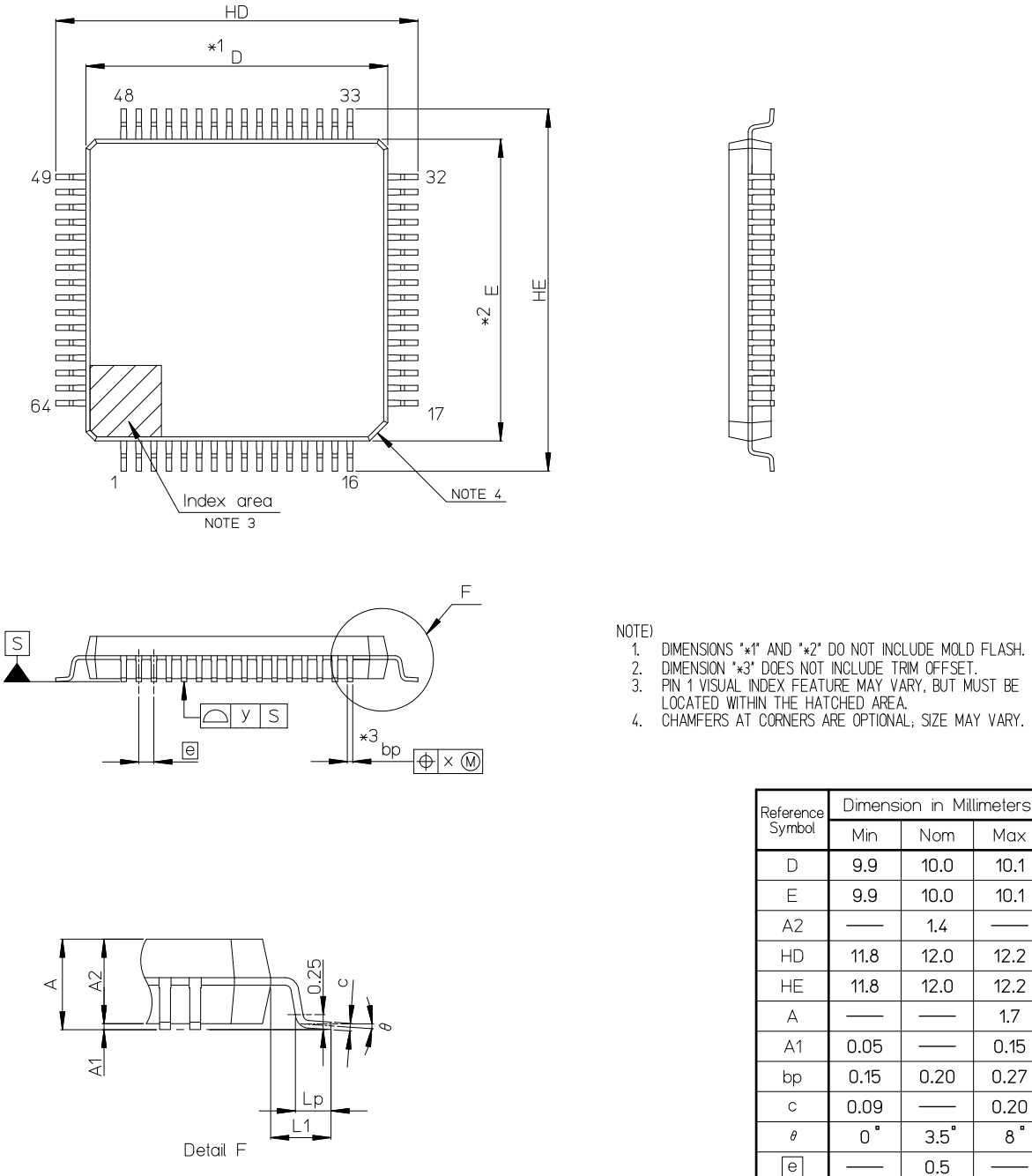
Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK should be ±3.5%.



Note. Do not apply the power supply voltage to the VCL pin.
Use a 4.7-µF multilayer ceramic for the VCL pin and place it close to the pin.
A recommended value is shown for the capacitance of the bypass capacitors.

Figure 5.68 Connecting Capacitors (80 Pins)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP64-10x10-0.50	PLQP0064KB-C	——	0.3g



NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.
3. PIN 1 VISUAL INDEX FEATURE MAY VARY, BUT MUST BE LOCATED WITHIN THE HATCHED AREA.
4. CHAMFERS AT CORNERS ARE OPTIONAL; SIZE MAY VARY.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	9.9	10.0	10.1
E	9.9	10.0	10.1
A2	——	1.4	——
HD	11.8	12.0	12.2
HE	11.8	12.0	12.2
A	——	——	1.7
A1	0.05	——	0.15
bp	0.15	0.20	0.27
c	0.09	——	0.20
θ	0°	3.5°	8°
e	——	0.5	——
x	——	——	0.08
y	——	——	0.08
Lp	0.45	0.6	0.75
L1	——	1.0	——

Figure D 64-Pin LFQFP (PLQP0064KB-C)